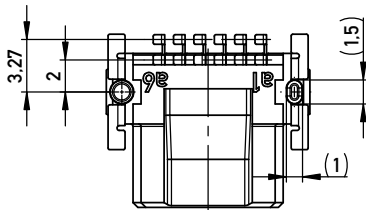
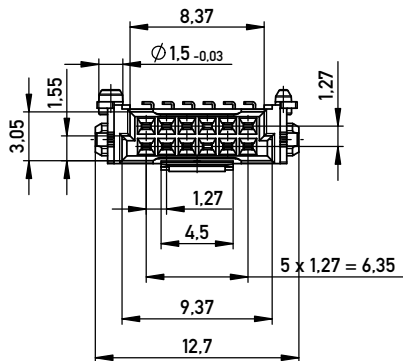
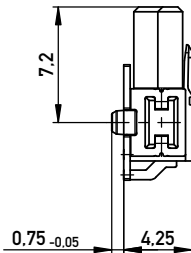
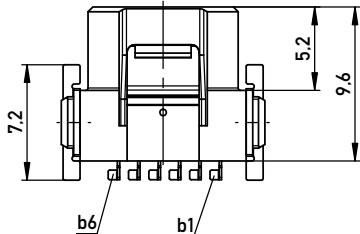
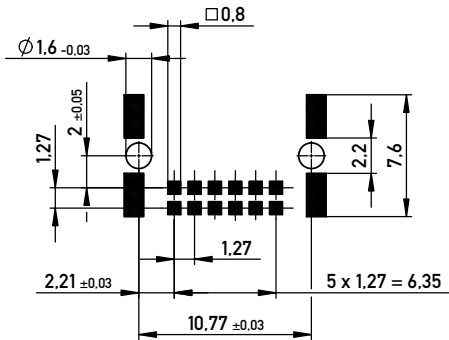
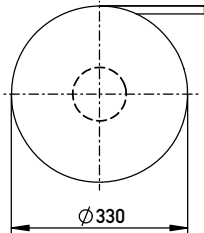


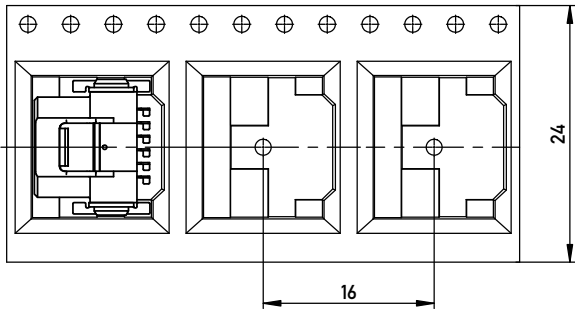
Leiterplatten-Layout Vorschlag für SMT
PCB-Layout Proposal for SMT



Verpackt im Gurt nach DIN IEC 60286-3
Tape on Reel Packaging according to DIN IEC 60286-3
Verpackungseinheit: 560 Stück
Packaging unit: 560 pcs



Abspulrichtung - Reel off Direction



Anforderungsstufe 1
Performance Level 1
Kontaktbereich vergoldet
Mating Area gold plating
Anschlussbereich verzinkt 4-6 µm
Terminal Area 4-6 µm tin plating
Koplanarität der Anschlüsse ≤ 0.1 mm
Coplanarity Area of Termination ≤ 0.1 mm

Copyright by ERNI GmbH
Proprietary notice pursuant to ISO 9001 to be observed.

				mit Verriegelung	
				with locking mechanism	
Information:		Tolerances	 All Dimensions in mm	Scale	3:1
All rights reserved. Only for Information. To ensure that this is the latest version of this drawing, please contact one of the ERNI companies before using.		Subject to modification without prior notice. Drawing will not be updated.		Designation	
				Federl. SMC-Q 12-SMD-BA7	
				Female SMC-Q 12-SMD-type7	
				254262	
b		23.04.2014		I	
Index		Date		A3	
				Class	SMCQ

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

[ERNI Electronics:](#)

[254262](#)